## FEATURES

Low Power
$1.7 \mathrm{~mA} /$ Amplifier Supply Current
Fully Specified for $\pm 5 \mathrm{~V}$ and +5 V Supplies
High Output Current, 125 mA
High Speed
$350 \mathrm{MHz},-3 \mathrm{~dB}$ Bandwidth ( $\mathbf{G}=+1$ )
$150 \mathrm{MHz},-3 \mathrm{~dB}$ Bandwidth ( $\mathrm{G}=+2$ )
2,250 V/ $\mu \mathrm{s}$ Slew Rate
20 ns Settling Time to 0.1\%
Low Distortion

- 72 dBc Worst Harmonic @ $500 \mathrm{kHz}, \mathrm{R}_{\mathrm{L}}=100 \Omega$
-66 dBc Worst Harmonic @ $5 \mathrm{MHz}, \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega$
Good Video Specifications ( $\mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega, \mathbf{G}=+\mathbf{2}$ ) 0.02\% Differential Gain Error
$0.06^{\circ}$ Differential Phase Error
Gain Flatness $\mathbf{0 . 1}$ dB to $\mathbf{4 0} \mathbf{~ M H z}$
60 ns Overdrive Recovery
Low Offset Voltage, 1.5 mV
Low Voltage Noise, $2.5 \mathrm{nV} / \sqrt{\mathrm{Hz}}$
Available in 8-Lead SOIC, and 8-Lead microSOIC


## APPLICATIONS <br> XDSL, HDSL Line Driver <br> ADC Buffer <br> Professional Cameras <br> CCD Imaging System <br> Ultrasound Equipment <br> Digital Camera

## PRODUCT DESCRIPTION

The AD 8012 is a dual low power current feedback amplifier capable of providing 350 M Hz bandwidth while using only 1.7 mA per amplifier. It is intended for use in high frequency, wide dynamic range systems where low distortion, high speed are essential and low power is critical.
With only 1.7 mA of supply current, the AD8012 also offers exceptional ac specs such as 20 ns settling time and $2,250 \mathrm{~V} / \mu \mathrm{s}$ slew rate. The video specifications are $0.02 \%$ differential gain and 0.06 degree differential phase, excellent for such a low power amplifier. In addition, the AD 8012 has a low offset of 1.5 mV .
The AD 8012 is well suited for any application that requires high performance with minimal power.
The product is available in standard 8-lead SOIC or microSOIC packages and operates over the industrial temperature range $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.

## REV. 0

[^0]FUNCTIONAL BLOCK DIAGRAM



Figure 1. Distortion vs. Load Resistance, $V_{S}= \pm 5 \mathrm{~V}$, Frequency $=500$ kHz


Figure 2. Differential Drive Circuit for XDSL Applications

AD8012- SPECIFICATIONS
DUAL SUPPLY (@ $T_{A}=+25^{\circ} \mathrm{C}, V_{S}= \pm 5 \mathrm{~V}, G=+2, R_{L}=100 \Omega, R_{F}=R_{G}=750 \Omega$, unless otherwise noted)

| Parameter | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: |
| DYNAM IC PERFORMANCE -3 dB Small Signal Bandwidth <br> 0.1 dB Bandwidth Large Signal Bandwidth Slew Rate Rise and F all Time Settling Time Overdrive Recovery | $\begin{aligned} & \mathrm{G}=+1, \mathrm{~V}_{\text {OUT }}<0.4 \mathrm{~V} \text { p-p, } \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega \\ & \mathrm{G}=+2, \mathrm{~V}_{\text {OUT }}<0.4 \mathrm{~V} p-\mathrm{p}, \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega \\ & \mathrm{G}=+2, \mathrm{~V}_{\text {OUT }}<0.4 \mathrm{~V} p-\mathrm{p}, \mathrm{R}_{\mathrm{L}}=100 \Omega \\ & \mathrm{~V}_{\text {OUT }}<0.4 \mathrm{~V} \text { p-p, } \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega / 100 \Omega \\ & \mathrm{~V}_{\text {OUT }}=4 \mathrm{~V} \mathrm{p}-\mathrm{p} \\ & \mathrm{~V}_{\text {OUT }}=4 \mathrm{~V} \text { p-p } \\ & \mathrm{V}_{\text {OUT }}=2 \mathrm{~V} \mathrm{p}-\mathrm{p} \\ & 0.1 \%, \mathrm{~V}_{\text {OUT }}=2 \mathrm{~V} \text { p-p } \\ & 0.02 \%, \mathrm{~V}_{\text {OUT }}=2 \mathrm{~V} \text { p-p } \\ & 2 \times \text { Overdrive } \end{aligned}$ | $\begin{aligned} & 270 \\ & 95 \end{aligned}$ | $\begin{aligned} & 350 \\ & 150 \\ & 90 \\ & 40 / 23 \\ & 75 \\ & 2,250 \\ & 3 \\ & 20 \\ & 35 \\ & 60 \end{aligned}$ |  | M Hz <br> MHz <br> MHz <br> MHz <br> MHz <br> $\mathrm{V} / \mu \mathrm{s}$ <br> ns <br> ns <br> ns <br> ns |
| NOISE/HARMONIC PERFORMANCE <br> Distortion <br> 2nd H armonic <br> 3rd Harmonic <br> Output IP3 <br> IM D <br> Crosstalk <br> Input Voltage N oise <br> Input Current N oise <br> D ifferential Gain <br> Differential Phase | $\begin{aligned} & \text { Vout }=2 \mathrm{~V} \mathrm{p-p,G}=+2 \\ & 500 \mathrm{kHz}, \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega / 100 \Omega \\ & 5 \mathrm{M} \mathrm{~Hz}, \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega / 100 \Omega \\ & 500 \mathrm{kHz}, \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega / 100 \Omega \\ & 5 \mathrm{M} \mathrm{~Hz}, \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega / 100 \Omega \\ & 500 \mathrm{kHz}, \Delta \mathrm{f}=10 \mathrm{kHz}, \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega / 100 \Omega \\ & 500 \mathrm{kHz}, \Delta \mathrm{f}=10 \mathrm{kHz}, \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega / 100 \Omega \\ & 5 \mathrm{M} \mathrm{~Hz}, \mathrm{R}_{\mathrm{L}}=100 \Omega \\ & \mathrm{f}=10 \mathrm{kHz} \\ & \mathrm{f}=10 \mathrm{kHz},+\operatorname{nput},-\operatorname{lnput} \\ & \mathrm{f}=3.58 \mathrm{M} \mathrm{~Hz}, \mathrm{R}_{\mathrm{L}}=150 \Omega / 1 \mathrm{k} \Omega, \mathrm{G}=+2 \\ & \mathrm{f}=3.58 \mathrm{M} \mathrm{~Hz}, \mathrm{R}_{\mathrm{L}}=150 \Omega / 1 \mathrm{k} \Omega, \mathrm{G}=+2 \\ & \hline \end{aligned}$ |  | $\begin{aligned} & -89 /-73 \\ & -78 /-62 \\ & -84 /-72 \\ & -66 /-52 \\ & 30 / 40 \\ & -79 /-77 \\ & -70 \\ & 2.5 \\ & 15 \\ & 0.02 / 0.02 \\ & 0.3 / 0.06 \end{aligned}$ |  | dBc <br> dBC <br> dBc <br> $d B c$ <br> dBm <br> $d B C$ <br> dB <br> $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ <br> $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ <br> \% <br> D egrees |
| DC PERFORM ANCE Input Offset Voltage Open-L oop T ransimpedance | $\begin{aligned} & \mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }} \\ & \mathrm{V}_{\text {OUT }}= \pm 2 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=100 \Omega \\ & \mathrm{~T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }} \end{aligned}$ | $\begin{aligned} & 240 \\ & 200 \end{aligned}$ | $\begin{aligned} & \pm 1.5 \\ & 500 \end{aligned}$ | $\begin{aligned} & \pm 4 \\ & \pm 5 \end{aligned}$ | $\begin{aligned} & \mathrm{mV} \\ & \mathrm{mV} \\ & \mathrm{k} \Omega \\ & \mathrm{k} \Omega \end{aligned}$ |
| INPUT CHARACTERISTICS <br> Input Resistance <br> Input C apacitance <br> Input Bias Current <br> Common-M ode Rejection Ratio Input Common-M ode Voltage Range | +Input <br> +Input <br> +Input, -Input <br> +Input, -Input, $\mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }}$ <br> $\mathrm{V}_{\mathrm{CM}}= \pm 2.5 \mathrm{~V}$ | $\begin{aligned} & -56 \\ & \pm 3.8 \end{aligned}$ | $\begin{aligned} & 450 \\ & 2.3 \\ & \pm 3 \\ & \\ & -60 \\ & \pm 4.1 \end{aligned}$ | $\begin{aligned} & \pm 12 \\ & \pm 15 \end{aligned}$ | $k \Omega$ <br> pF <br> $\mu \mathrm{A}$ <br> $\mu \mathrm{A}$ <br> dB <br> V |
| OUTPUT CHARACTERISTICS <br> Output Resistance <br> Output Voltage Swing <br> Output Current <br> Short Circuit Current | $\begin{aligned} & G=+2 \\ & T_{\text {MIN }}-T_{\text {MAX }} \end{aligned}$ | $\begin{aligned} & \pm 3.85 \\ & 70 \end{aligned}$ | $\begin{aligned} & 0.1 \\ & \pm 4 \\ & 125 \\ & 500 \end{aligned}$ |  | $\begin{aligned} & \Omega \\ & \mathrm{V} \\ & \mathrm{~mA} \\ & \mathrm{~mA} \end{aligned}$ |
| POWER SUPPLY <br> Supply Current/Amp <br> Operating R ange <br> Power Supply Rejection R atio | $\mathrm{T}_{\text {min }}-\mathrm{T}_{\text {max }}$ Dual Supply | $\begin{aligned} & \pm 1.5 \\ & -58 \end{aligned}$ | $1.7$ $-60$ | $\begin{aligned} & 1.8 \\ & 1.9 \\ & \pm 6.0 \end{aligned}$ | $\begin{aligned} & \mathrm{mA} \\ & \mathrm{~mA} \\ & \mathrm{~V} \\ & \mathrm{~dB} \end{aligned}$ |

Specifications subject to change without notice.

## SINGLE SUPPLY (@ $T_{A}+25^{\circ} \mathrm{C}, V_{S}=+5 V, G=+2, R_{l}=100 \Omega, R_{F}=R_{G}=750 \Omega$, unless othervise noted)

| Parameter | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: |
| DYNAMIC PERFORMANCE <br> -3 dB Small Signal Bandwidth <br> 0.1 dB Bandwidth <br> Large Signal Bandwidth <br> Slew Rate <br> Rise and Fall Time Settling Time <br> Overdrive Recovery |  | $\begin{aligned} & 220 \\ & 90 \end{aligned}$ | $\begin{aligned} & 300 \\ & 140 \\ & 85 \\ & 43 / 24 \\ & 60 \\ & 1,200 \\ & 2 \\ & 25 \\ & 40 \\ & 60 \end{aligned}$ |  | M Hz <br> M Hz <br> M Hz <br> M Hz <br> M Hz <br> $\mathrm{V} / \mathrm{\mu s}$ <br> ns <br> ns <br> ns <br> ns |
| NOISE/HARM ONIC PERFORMANCE <br> Distortion <br> 2nd Harmonic <br> 3rd Harmonic <br> Output IP3 <br> IM D <br> C rosstalk <br> Input Voltage N oise <br> Input Current N oise <br> D ifferential Gain <br> Differential Phase |  |  | $\begin{aligned} & -87 /-71 \\ & -77 /-61 \\ & -89 /-72 \\ & -87 /-52 \\ & 30 / 40 \\ & -77 /-80 \\ & -70 \\ & 2.5 \\ & 15 \\ & \\ & 0.03 / 0.03 \\ & 0.4 / 0.08 \end{aligned}$ |  | dBc <br> dBc <br> dBc <br> dBC <br> dBm <br> dBc <br> dB <br> $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ <br> $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ <br> \% <br> D egrees |
| DC PERFORMANCE Input Offset Voltage Open-L oop T ransimpedance | $\begin{aligned} & \mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }} \\ & V_{\text {OUT }}=2 \mathrm{~V} \text { p-p, } \mathrm{R}_{\mathrm{L}}=100 \Omega \\ & \mathrm{~T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }} \end{aligned}$ | $\begin{aligned} & 200 \\ & 150 \end{aligned}$ | $\begin{aligned} & \pm 1 \\ & 400 \end{aligned}$ | $\begin{aligned} & \pm 3 \\ & \pm 4 \end{aligned}$ | $\begin{aligned} & \mathrm{mV} \\ & \mathrm{mV} \\ & \mathrm{k} \Omega \\ & \mathrm{k} \Omega \\ & \hline \end{aligned}$ |
| INPUT CHARACTERISTICS <br> Input Resistance <br> Input C apacitance <br> Input Bias Current <br> Common-M ode Rejection Ratio Input C ommon-M ode Voltage Range | +Input <br> +Input <br> +Input, -Input <br> +Input, -Input, $\mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }}$ <br> $\mathrm{V}_{\mathrm{CM}}=1.5 \mathrm{~V}$ to 3.5 V | $\begin{aligned} & -56 \\ & 1.5 \text { to } 3.5 \end{aligned}$ | $\begin{aligned} & 450 \\ & 2.3 \\ & \pm 3 \\ & \\ & -60 \\ & 1.2 \text { to } 3.8 \end{aligned}$ | $\begin{aligned} & \pm 12 \\ & \pm 15 \end{aligned}$ | $\begin{aligned} & \mathrm{k} \Omega \\ & \mathrm{pF} \\ & \mu \mathrm{~A} \\ & \mu \mathrm{~A} \\ & \mathrm{~dB} \\ & \mathrm{~V} \end{aligned}$ |
| OUTPUT CHARACTERISTICS <br> Output Resistance <br> Output Voltage Swing <br> Output Current <br> Short Circuit Current | $\begin{aligned} & G=+2 \\ & T_{\text {MIN }}-T_{\text {MAX }} \end{aligned}$ | $\begin{aligned} & 1 \text { to } 4 \\ & 50 \end{aligned}$ | 0.1 0.9 to 4.2 100 <br> 500 |  | $\begin{aligned} & \Omega \\ & \mathrm{V} \\ & \mathrm{~mA} \end{aligned}$ $\begin{gathered} \mathrm{mA} \\ \mathrm{~mA} \end{gathered}$ |
| POWER SUPPLY <br> Supply Current/Amp <br> Operating R ange Power Supply Rejection Ratio | $\mathrm{T}_{\text {min }}-\mathrm{T}_{\text {max }}$ Single Supply | $\begin{aligned} & 3 \\ & -58 \end{aligned}$ | $\begin{aligned} & 1.55 \\ & -60 \end{aligned}$ | 1.75 1.85 12 | $\begin{aligned} & \mathrm{mA} \\ & \mathrm{~mA} \\ & \mathrm{~V} \\ & \mathrm{~dB} \end{aligned}$ |

[^1]
## ABSOLUTE MAXIMUM RATINGS ${ }^{\mathbf{1}}$

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ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Options |
| :--- | :--- | :--- | :--- |
| AD 8012AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-L ead SOIC | SO-8 |
| AD 8012ARM | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8 -L ead microSOIC | RM -08 |

## MAXIMUM POWER DISSIPATION

T he maximum power that can be safely dissipated by the AD 8012 is limited by the associated rise in junction temperature. The maximum safe junction temperature for plastic encapsulated devices is determined by the glass transition temperature of the plastic, approximately $+150^{\circ} \mathrm{C}$. Temporarily exceeding this limit may cause a shift in parametric performance due to a change in the stresses exerted on the die by the package. Exceeding a junction temperature of $+175^{\circ} \mathrm{C}$ for an extended period can result in device failure.
T he output stage of the AD 8012 is designed for maximum load current capability. As a result, shorting the output to common can cause the AD 8012 to source or sink 500 mA . To ensure proper operation, it is necessary to observe the maximum power derating curves. Direct connection of the output to either power supply rail can destroy the device.


Figure 3. Plot of Maximum Power Dissipation vs. Temperature for AD8012

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD 8012 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

## Typical Performance Characteristics- AD8012



Figure 4. Test Circuit; Gain $=+2$


Figure 5.* 100 mV Step Response; $G=+2, V_{S}= \pm 2.5 \mathrm{~V}$ or $\pm 5 \mathrm{~V}, R_{L}=1 \mathrm{k} \Omega$


Figure 6. 4 V Step Response; $G=+2, V_{S}= \pm 5 \mathrm{~V}, R_{L}=1 \mathrm{k} \Omega$


Figure 7. Test Circuit; Gain $=-1$


Figure 8.* 100 mV Step Response; $G=-1, V_{S}= \pm 2.5 \mathrm{~V}$ or $\pm 5 \mathrm{~V}, R_{L}=1 \mathrm{k} \Omega$


Figure 9. 4 V Step Response; $G=-1, V_{S}= \pm 5 \mathrm{~V}, R_{L}=1 \mathrm{k} \Omega$


Figure 10.* 100 mV Step Response; $G=+2, V_{S}= \pm 2.5 \mathrm{~V}$ or $\pm 5 \mathrm{~V}, R_{L}=100 \Omega$


Figure 11. 2 V Step Response; $G=+2, V_{S}= \pm 2.5 \mathrm{~V}, R_{L}=100 \Omega$


Figure 12. $4 V$ Step Response; $G=+2, V_{S}= \pm 5 V, R_{L}=100 \Omega$


Figure 13.* 100 mV Step Response; $G=-1, V_{S}= \pm 2.5 \mathrm{~V}$ or $\pm 5 \mathrm{~V}, R_{L}=100 \Omega$


Figure 14. 2 V Step Response; $G=-1, V_{S}= \pm 2.5 \mathrm{~V}, R_{L}=100 \Omega$


Figure 15. $4 V$ Step Response; $G=-1, V_{S}= \pm 5 V, R_{L}=100 \Omega$


Figure 16. Distortion vs. Load Resistance; $V_{S}= \pm 5 \mathrm{~V}$, Frequency $=500 \mathrm{kHz}$


Figure 17. Distortion vs. Frequency; $V_{S}= \pm 5 \mathrm{~V}$


Figure 18. Gain Flatness; $V_{S}= \pm 5 \mathrm{~V}$


Figure 19. Distortion vs. Load Resistance; $V_{s}=+5 \mathrm{~V}$, Frequency $=500 \mathrm{kHz}$


Figure 20. Distortion vs. Frequency; $V_{S}=+5 \mathrm{~V}$


Figure 21. Gain Flatness; $V_{s}=+5 \mathrm{~V}$


Figure 22. Frequency Response; $V_{s}= \pm 5 \mathrm{~V}$


Figure 23. Output Voltage vs. Frequency; $V_{S}= \pm 5 \mathrm{~V}$, $G=+2 \mathrm{~V}, R_{L}=100 \Omega$


Figure 24. CMRR vs. Frequency; $V_{s}= \pm 5 \mathrm{~V},+5 \mathrm{~V}$


Figure 25. Frequency Response; $V_{S}=+5 \mathrm{~V}$


Figure 26. Output Voltage vs. Frequency; $V_{s}=+5 \mathrm{~V}$, $G=+2 V, R_{L}=100 \Omega$


Figure 27. PSRR vs. Frequency; $V_{S}= \pm 5 \mathrm{~V},+5 \mathrm{~V}$


Figure 28. Output Resistance vs. Frequency


Figure 29. Open-Loop Transimpedance and Phase vs. Frequency


Figure 30. Output Swing vs. Load


Figure 31. Noise vs. Frequency


Figure 32. Output Swing vs. Supply


Figure 33. Settling Time, $V_{S}= \pm 5 \mathrm{~V}$


Figure 34. Frequency Response; $V_{S}= \pm 5 \mathrm{~V}$


Figure 35. Gain Flatness; $V_{S}= \pm 5 \mathrm{~V}$


Figure 36. Crosstalk vs. Frequency


Figure 37. Frequency Response; $V_{S}=+5 \mathrm{~V}$


Figure 38. Gain Flatness; $V_{S}=+5 \mathrm{~V}$


Figure 39. Overdrive Recovery; $V_{S}= \pm 5 V, G=+2$, $R_{F}=750 \Omega, R_{L}=100 \Omega, V_{I N}=3 V p-p(T=1 \mu s)$

## THEORY OF OPERATION

The AD 8012 is a dual high speed CF amplifier that attains new levels of bandwidth (BW), power, distortion and signal swing capability. Its wide dynamic performance (including noise) is the result of both a new complementary high speed bipolar process and a new and unique architectural design. The AD8012 basically uses a two gain stage complementary design approach versus the traditional "single stage" complementary mirror structure sometimes referred to as the $N$ elson amplifier. Though twin stages have been tried before, they typically consumed high power since they were of a folded cascade design much like the AD 9617. T his design allows for the standing or quiescent current to add to the high signal or slew current-induced stages. In the time domain, the large signal output rise/fall time and slew rate is typically controlled by the small signal BW of the amplifier and the input signal step amplitude respectively, not the dc quiescent current of the gain stages (with the exception of input level shift diodes Q1/Q2). U sing two stages vs. one also allows for a higher overall gain bandwidth product (GBWP) for the same power, thus lower signal distortion and the ability to drive heavier external loads. In addition, the second gain stage also isolates (divides down) A3's input reflected load drive and the nonlinearities created resulting in relatively lower distortion and higher open-loop gain.
Overall, when "high" external load drive and low ac distortion is a requirement, a twin gain stage integrating amplifier like the AD 8012 will provide excellent results for lower power over the
traditional single stage complementary devices. In addition, being a CF amplifier, closed-loop BW variations versus external gain variations (varying RN) will be much lower compared to a VF op amp, where the BW varies inversely with gain. Another key attribute of this amplifier is its ability to run on a single 5 V supply due in part to its wide common-mode input and output voltage range capability. F or 5 V supply operation, the device obviously consumes half the quiescent power (vs. 10 V supply) with little degradation in its ac and dc performance characteristics. See data sheet comparisons.

## DC GAIN CHARACTERISTICS

$G$ ain stages $A 1 / A 1 B$ and $A 2 / A 2 B$ combined provide negative feedforward transresistance gain. See Figure 40. Stage A3 is a unity gain buffer which provides external load isolation to A2. E ach stage uses a symmetrical complementary design. (A 3 is also complementary though not explicitly shown). This is done to reduce both second order signal distortion and overall quiescent power as discussed above. In the quasi dc to low frequency region, the closed loop gain relationship can be approximated as:

$$
\begin{array}{ll}
G=1+R_{F} / R_{N} & \text { noninverting operation } \\
G=-R_{F} / R_{N} & \text { inverting operation }
\end{array}
$$

These basic relationships above are common to all traditional operational amplifiers.


Figure 40. Simplified Block Diagram

## AD8012

## APPLICATIONS

## Line Driving for HDSL

High Bitrate Digital Subscriber Line (HDSL) is becoming popular as a means of providing full duplex data communication at rates up to 1.544 M BPS or 2.048 M BPS over moderate distances via conventional telephone twisted pair wires. T raditional T 1 (E1 in Europe) requires repeaters every 3,000 feet to 6,000 feet to boost the signal strength and allow transmission over distances of up to 12,000 feet. In order to achieve repeaterless transmission over this distance, an HDSL modem requires transmitted power level of +13.5 dBm (assuming a line impedance of $135 \Omega$ ).
HDSL uses the T wo Binary/O ne Quaternary line code (2B1Q). A sample 2B1Q waveform is shown in Figure 41. The digital bit stream is broken up into groups of two bits. Four analogue voltages (called quaternary symbols) are used to represent the four possible combinations of two bits. T hese symbols are assigned arbitrary names $+3,+1,-1$ and -3 . The corresponding voltage levels are produced by a DAC that is usually part of an Analog Front End Circuit (AFEC). B efore being applied to the line, the DAC output is low-pass filtered and acquires the sinusoidal form shown in Figure 41. Finally, the filtered signal is applied to the line driver. The line voltages that correspond to the quaternary symbols $+3,+1,-1$ and -3 are $2.64 \mathrm{~V}, 0.88 \mathrm{~V}$, -0.88 V and -2.64 V . This gives a peak-to-peak line voltage of 5.28 V .


Figure 41. Time Domain Representation of a HDSL Signal
$M$ any of the elements of a classic differential line driver are shown in the H DSL line driver in Figure 42. A 6 V peak-topeak differential signal is applied to the input. The differential gain of the amplifier ( $1+2 R_{F} / R_{G}$ ) is set to +2 , so the resulting differential output signal is $12 \mathrm{~V} p-\mathrm{p}$.
As is normal in telephony applications, a transformer galvanically isolates the differential amplifier from the line. In this case a 1:1 turns ratio is used. In order to correctly terminate the line, it is necessary to set the output impedance of the amplifier to be equal to the impedance of the line being driven ( $135 \Omega$ in this case). Because the transformer has a turns ratio of $1: 1$, the impedance reflected from the line is equal to the line impedance of $135 \Omega\left(R_{\text {REFL }}=R_{\text {LINE }} / T\right.$ urns Ratio $\left.{ }^{2}\right)$. As a result, two $66.5 \Omega$ resistors correctly terminate the line.


Figure 42. Differential for HDSL Applications
The immediate effect of back-termination is that the signal from the amplifier is halved before being applied to the line. This doubles the power the amplifier must deliver. H owever, the back-termination resistors also play an important second role.
Full-duplex data transmission systems like H D SL simultaneously transmit data in both directions. As a result, the signal on the line and across the back termination resistors is the composite of the transmitted and received signal. T he termination resistors are used to tap off this signal and feed it to the receive circuitry. Because the receive circuitry "knows" what is being transmitted, the transmitted data can be subtracted from the digitized composite signal to reveal the received data.
Driving a line with a differential signal offers a number of advantages compared to a single-ended drive. Because the two outputs are always 180 degrees out of phase relative to one another, the differential signal output is double the output amplitude of either of the op amps. As a result, the differential amplifier can have a peak-to-peak swing of 16 V (each op amp can swing to $\pm 4 \mathrm{~V}$ ), even though the power supply is $\pm 5 \mathrm{~V}$.
In addition to this, even-order harmonics (2nd, 4th, 6th, etc.) of the two single-ended outputs tend to cancel out one another, so the T otal H armonic Distortion (quadratic sum of all harmonics) decreases compared to the single-ended case, even as the signal amplitude is doubled. This is particularly advantageous for the case of the second harmonic. As it is very close to the fundamental, filtering becomes difficult. In this application, the THD is dominated by the third harmonic which is 65 dB below the carrier (i.e., Spurious F ree D ynamic R ange $=-65 \mathrm{dBc}$ ).
Differential line driving also helps to preserve the integrity of the transmitted signal in the presence of Electro-M agnetic Interference (EMI). EM I tends to induce itself equally on to both the positive and negative signal line. As a result, a receiver with good common-mode rejection, will amplify the original signal while rejecting induced (common-mode) EMI.

## Choosing the Appropriate Turns Ratio for the Transformer

Increasing the peak-to-peak output signal from the amplifier in the previous example, combined with a variation in the turns ratio of the transformer, can yield further enhancements to the circuit. The output signal swing of the AD 8012 can be increased to about $\pm 3.9 \mathrm{~V}$ before clipping occurs. This increases the peak-to-peak output of the differential amplifier to 15.6 V . Because the signal applied to the primary winding is now bigger, the transformer turns ratio of 1:1 can be replaced with a (stepdown) turns ratio of about 1.3:1 (from amplifier to line). T his steps the 7.8 V peak-to-peak primary voltage down to 6 V . T his is the same secondary voltage as before so the resulting power delivered to the line is the same.
The received signal, which is small relative to the transmitted signal, will, however be stepped up by a factor of 1.3. Amplifying the received signal in this manner enhances its signal-to-noise ratio and is useful when the received signal is small compared to the to-be-transmitted signal.
The impedance reflected from the $135 \Omega$ line now becomes $228 \Omega$ ( $1.3^{2}$ times $135 \Omega$ ). With a correctly terminated line, the amplifier must now drive a total load of $456 \Omega(114 \Omega+114 \Omega$ $+228 \Omega$ ), considerably less than the original $270 \Omega$ load. This reduces the drive current from the op amps by about $40 \%$.
M ore significant however is the reduction in dynamic power consumption; that is, the power the amplifier must consume in order to deliver the load power. Increasing the output signal so that it is as close as possible to the power rails, minimizes the power consumed in the amplifier.
There is, however, a price to pay in terms of increased signal distortion. Increasing the output signal of each op amp from the original $\pm 3 \mathrm{~V}$ to $\pm 3.9 \mathrm{~V}$ reduces the Spurious Free D ynamic $R$ ange (SFDR) from -65 dB to -50 dB (measured at 500 kHz ), even though the overall load impedance has increased from $270 \Omega$ to $456 \Omega$.

## LAYOUT CONSIDERATIONS

The specified high speed performance of the AD 8012 requires careful attention to board layout and component selection. T able I shows recommended component values for the AD 8012 and Figures 44-49 show recommended layouts for the 8-lead SOIC and microSOIC packages for a positive gain. Proper RF design techniques and low parasitic component selections are mandatory.

The PCB should have a ground plane covering all unused portions of the component side of the board to provide a low impedance ground path. The ground plane should be removed from the area near the input pins to reduce stray capacitance. Chip capacitors should be used for supply bypassing (see Figure 43). One end should be connected to the ground plane and the other within $1 / 8 \mathrm{in}$. of each power pin. An additional ( $4.7 \mu \mathrm{~F}-10 \mu \mathrm{~F}$ ) tantalum electrolytic capacitor should be connected in parallel.
The feedback resistor should be located close to the inverting input pin in order to keep the stray capacitance at this node to a minimum. Capacitance greater than 1.5 pF at the inverting input will significantly affect high speed performance when operating at low noninverting gains.
Stripline design techniques should be used for long signal traces (greater than about 1 in .). These should be designed with the proper system characteristic impedance and be properly terminated at each end.


Figure 43. Inverting and Noninverting Configurations

Table I. Typical Bandwidth vs. Gain Setting Resistors

| Gain | $\mathbf{R}_{\mathbf{F}}$ |  |  | Small Signal -3 $\mathbf{d B} \mathbf{B W}(\mathbf{M H z})$, <br> $\mathbf{R}_{\mathbf{G}}= \pm \mathbf{5} \mathbf{V}, \mathbf{R}_{\mathbf{L}}=\mathbf{1} \mathbf{k} \boldsymbol{\Omega}$ |
| :--- | :--- | :--- | :--- | :--- |
| -1 | $750 \Omega$ | $750 \Omega$ | $53.6 \Omega$ | 110 |
| +1 | $750 \Omega$ | - | $49.9 \Omega$ | 350 |
| +2 | $750 \Omega$ | $750 \Omega$ | $49.9 \Omega$ | 150 |
| +10 | $750 \Omega$ | $82.5 \Omega$ | $49.9 \Omega$ | 40 |

[^2]
0 UNIUERSAL
SO NONINUERTER

$\perp$


Figure 45. Universal SOIC Noninverter Top

UNIUERSAL SO NONINUERTER BOTTOM


Figure 46. Universal SOIC Noninverter Bottom



MINI-SO
NONI NUERTER
L

Figure 47. Universal microSOIC Noninverter Top Silkscreen


Figure 48. Universal microSOIC Noninverter Top

MICRO-SO NONINUERTER


Figure 49. Universal microSOIC Noninverter Bottom

## OUTLINE DIMENSIONS

Dimensions shown in inches and (mm).


## 8-Lead microSOIC

(RM-08)



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[^1]:    Specifications subject to change without notice.

[^2]:    $\mathrm{R}_{\mathrm{T}}$ chosen for $50 \Omega$ characteristic input impedance.

